

# Micro- and Nanostructuring of Graphene on various Substrates using UV-NIL

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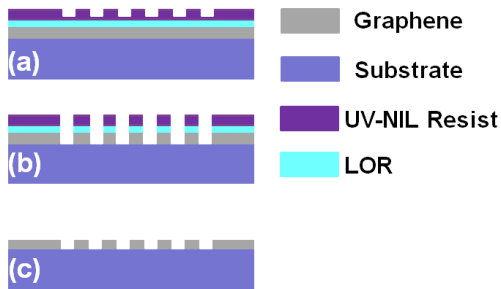
In this work we demonstrate the micro- and nanostructuring of graphene using UV-based Nanoimprint Lithography (NIL) on nickel, copper, or silica substrates. Graphene is a single graphite layer with carbon atoms arranged in a honeycomb crystal lattice with unique properties like a very high electron mobility of  $18000 \text{ cm}^2/\text{Vs}$  [1]. Exfoliated as well as chemical vapor deposited (CVD) graphene was used to demonstrate that our technique is suitable for large-area patterning ( $1 \times 1 \text{ cm}^2$ ). Feature sizes down to 20 nm were achieved by a wafer-scale process which opens up new possibilities for low-cost and high-throughput manufacturing of graphene-based devices for high frequency applications [2], graphene optoelectronics [3], [4] photonics [5], plasmonics [6].

The most frequently reported method to structure graphene is e-beam lithography [7], despite of its low throughput. NIL allows fast nanopatterning of structures on large areas and is therefore a suitable technique for future mass production. In the last years few approaches have been started to achieve structured graphene using NIL. Liang et al. have reported a method using exfoliation of graphene layers with a patterned graphite stamp [8] and electrostatic assisted exfoliation [9]. Moreover, first steps were undertaken by the same group to achieve nanopatterned graphene by thermal NIL on top of electrostatically exfoliated graphene flakes and subsequent oxygen-assisted etching [10]. One drawback of all these methods is the dependency on random graphene flakes which furthermore were subject to a varying number of layers. Our work represents the first comprehensive investigation of a potentially low-cost, direct imprint process capable of achieving large areas of micro- and nanostructured graphene showing a UV-based NIL process (Figure 1) on exfoliated graphene (Figure 2), on CVD graphene on nickel and copper substrates over  $1 \times 1 \text{ cm}^2$  [11], [12] (Figure 3) and patterning of CVD graphene transferred from copper onto silica (Figure 4). For the results shown here a two layer resist system (LOR1A and mr-UVCur06) was spin coated on a graphene substrate (Figure 1(a)). The mr-UVCur06 is structured using UV-based NIL on  $2.5 \times 2.5 \text{ cm}^2$  and the pattern is transferred to the substrate by reactive ion etching using oxygen (Figure 1(b)). Afterwards the LOR1A is dissolved in a developer such that the structured graphene layers remain (Figure 1(c)). The processed graphene films show electron mobilities of up to  $4.6 \cdot 10^3 \text{ cm}^2/\text{Vs}$ , which confirms them to exhibit state-of-the-art electronic quality.

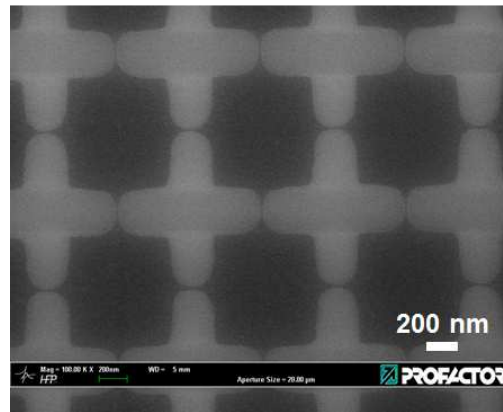
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## References

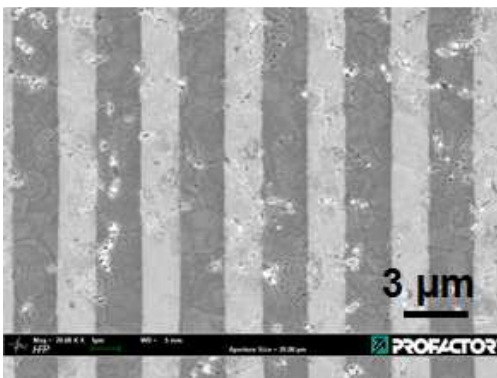
- [1] K.S. Novoselov et al., *Science* **2004**, 306, 666.
- [2] Y.M. Lin et al., *Science* **2010**, 327, 662.
- [3] T. Mueller et al., *Nature Photon.* **2010**, 4, 297.
- [4] M. Liu et al., *Nature* **2011**, 474, 64.
- [5] A. Vakil and N. Engheta, *Science* **2011**, 332, 1291.
- [6] F. Koppens et al., *Nano Lett.* **2011**, 11, 3370.
- [7] A.K. Geim et al., *Nature Mater.* **2007**, 6, 183.
- [8] X. Liang et al., *Nano Lett.* **2007**, 7, 3840.
- [9] X. Liang et al., *Nano Lett.* **2009**, 9, 467.
- [10] X. Liang et al., *Nano Lett.* **2010**, 10, 2454.
- [11] M. Losurdo et al., *J. Phys. Chem. C* **2011**, 115, 21804.
- [12] M. Losurdo et al., *Phys. Chem. Chem. Phys.* **2011**, 13, 20836.



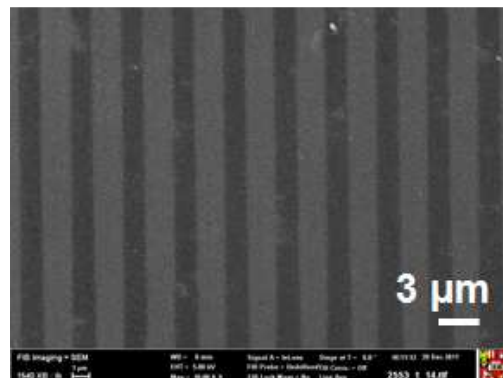
*Figure 1:* Schematic drawing of UV-based NIL structuring process of graphene using (a) spin coating of resists, (b) Imprinting and etching, (c) lift-off of resists and remaining patterned graphene.



*Figure 2:* Structured graphene with feature sizes down to 20 nm (dark area) and a period of 600 nm in either lateral direction.



*Figure 3:* Microstructured graphene on copper substrate with a patterned area of 1 x 1 cm<sup>2</sup>.



*Figure 4:* CVD graphene transferred on silica and microstructured by UV-based NIL.